



高速光耦
High Speed Photo
Coupler

ATM6XX

Product Data Sheet

AOTE DCC
RELEASE

台湾奥特半导体科技有限公司

TAIWAN AOTE SEMICONDUCTOR TECHNOLOGY CO.,LTD

www.aotesemi.com

概述 Description

ATM600、ATM601、ATM611 内部有一个 850nm 的 AlGaAs LED，其光学耦合到具有选通输出的超高速集成光电检测器。这些器件采用 5 引脚外形封装，符合标准封装外形。

The ATM600 ATM601 ATM611 optocoupler consists of a 850 nm AlGaAs LED, optically coupled to a very high speed integrated photo-detector logic gate with a strobable output. The devices are packaged in a 5-pin small outline package which conforms to the standard footprint.

特性 Features

- 输入-输出隔离电压 ($V_{ISO}=3750\text{ Vrms}$)
High isolation voltage between input and output($V_{ISO}=3750\text{ Vrms}$)
- 工作温度： $-40^{\circ}\text{C} \sim 85^{\circ}\text{C}$
Operating Temperature: $-40^{\circ}\text{C} \sim 85^{\circ}\text{C}$
- 符合加强绝缘标准
Meet reinforced insulation standards
- 符合安规标准： UL 1577， VDE DIN EN60747-5-5 (VDE 0884-5)， CQC11-471543-2022
Meet Safety standard : UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5)， CQC11-471543-2022

应用 Applications

- 开关电源， 智能电表
Switching power supply, intelligent meter
- 工业控制， 测量仪器
Industrial control, measuring instruments
- 办公设备， 比如复印机
Office equipment such as copiers
- 家用电器， 比如空调、风扇、热水器等
Household appliances: such as air conditioners, fans, water heaters, etc.

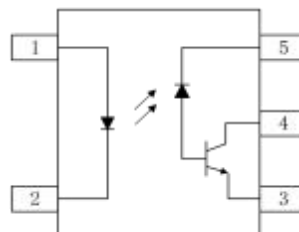
真值表 Truth table

LED	VO
OFF	H
ON	L

封装和原理图 Package and Schematic Diagram



SOP5



Pin Configuration

1. Anode
2. Cathode
3. GND
4. VO
5. VCC

注：在引脚 3 和 5 之间必须连接一个 0.1uF 的旁路电容器。

Note: 0.1uF bypass capacitor must be connected between pins 3 and 5.

产品型号命名规则 Order Code

AT M6XX - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦

- ① 公司代码 Company Code (AT: 奥特 Aote)
- ② 产品系列 Product Series (XX: 00, 01, 11)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (S: SOP)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (H:125°C)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中 “” 为奥特品牌 LOGO
“” denotes LOGO
- 印字中的 “XX” 代表产品分档：00、01、11
“XX” denotes the classification：00、01、11
- 印字中 “Y” 代表年份；A(2018),B(2019),C(2020)
“Y” denotes YEAR：A(2018), B(2019), C(2020)
- 印字中 “WW” 代表周号
“WW” denotes week's number
- 印字中 “E” 代表内部代码
“E” denotes Internal code
- 印字中的 “H” 代表无卤
“H” denotes Halogen-free



绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	> 5.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	> 5.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	> 0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	V_{IORM}	600	V_{peak}	DIN/EN/IEC EN60747-5-5
瞬态隔离电压 Transient isolation voltage	V_{IOTM}	5000	V_{peak}	DIN/EN/IEC EN60747-5-5
隔离电压 Isolation Voltage	V_{iso}	> 3750	V_{rms}	For 1 min

极限参数 Absolute Maximum Ratings ($T_a = 25^{\circ}\text{C}$)

参数 Parameter	符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	I_F	50 mA
	反向电压 Reverse Voltage	V_R	5 V
	功耗 Power Dissipation	P_D	100 mW
接收端 Output	电源电压 Supply Voltage	V_{CC}	7.0 V
	输出电流 Output Current	I_O	50 mA
	输出电压 Output Voltage	V_O	7.0 V
	集电极功耗 Collector Power Dissipation	P_C	85 mW
工作温度 Operating Temperature	T_{opr}	-40 ~ +125	$^{\circ}\text{C}$
存储温度 Storage Temperature	T_{stg}	-55 ~ +125	$^{\circ}\text{C}$
焊接温度 Soldering Temperature	T_{sol}	260	$^{\circ}\text{C}$

推荐工作条件 Recommended Operating Conditions

参数 Parameter	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
电源电压 Supply Voltages	V_{CC}	4.5	5.5	V
高电平输入电流 Input Current, High level	I_{FH}	5	10.0	mA
低电平输入电流 Input Current, Low level	I_{FL}	0	250	μA
操作温度 Operating Temperature	T_a	-40	125	$^{\circ}C$

产品特性参数 Electro-optical Characteristics ($T_a = 25^{\circ}C$)

参数 Parameter	符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage	$I_F = 10mA$	-	1.33	1.8	V
	反向击穿电压 Reverse Breakdown Voltage	$I_R = 10\mu A$	5	-	-	V
	电容 Capacitance	$V = 0, f = 1MHz$	-	70	-	pF
	正向电压的温度系数 Diode Temperature Coefficient	$I_F = 10mA$	-	-1.9	-	mV/ $^{\circ}C$
接收端 Output	高电平电源电流 High Level Supply Current	$V_{CC} = 5.5V, I_F = 0mA$	-	6.0	9	mA
	低电平电源电流 Low Level Supply Current	$V_{CC} = 5.5V, I_F = 0mA$	-	7.5	10	mA
传输特性 Transfer Characteristics	高电平输出电流 HIGH Level Output Current	$V_{CC} = 5.5V$ $V_O = 5.5V$ $I_F = 250\mu A$	-	2.1	30	μA
	低电平输出电压 LOW Level Output Voltage	$V_{CC} = 5.5V$ $I_F = 5mA$ $I_{CL} = 13mA$	-	0.4	0.6	V
	输入阈值电流 Input Threshold Current	$V_{CC} = 5.5V$ $V_O = 0.6V$ $I_{OL} = 13mA$	-	2.4	5	mA
隔离电压 Isolation Voltage	V_{ISO}	$R_H < 50\%$ $T_A = 25^{\circ}C$ $I_{FO} \leq 50\mu A$	3750	-	-	V_{RMS}
电阻 (输入到输出) Resistance (Input to Output)	R_{I-O}	$V_{I-O} = 500V$	-	10^{12}	-	Ω
电容 (输入到输出) Resistance (Input to Output)	C_{I-O}	$f = 1MHz$	-	0.6	-	pF

开关特性 Switching Specification($T_A = 25^\circ\text{C}$, $I_F = 7.5\text{mA}$, $V_{CC} = 5.0\text{V}$)

参数 Parameter	符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
输出高电平传播延迟 Propagation Delay Time to High Output Level	T_{PLH}	$C_L = 15\text{pF}$ $R_L = 350\Omega$ $T_A = 25^\circ\text{C}$	-	41	100	ns
输出低电平传播延迟 Propagation Delay Time to Low Output Level	T_{PHL}		-	50	100	ns
脉宽失真 Pulse Width Distortion	$ T_{PHL} - T_{PLH} $		-	9	35	ns
输出上升时间(10% - 90%) Output Rise Time (10 to 90%)	t_r		-	40	-	ns
输出下降时间(90% - 10%) Output Fall Time (90 to 10%)	t_f		-	10	-	ns
传播延迟偏斜 Propagation Delay Skew	t_{psk}		-	-	40	ns
输出高电平共模瞬态抑制 Common Mode Transient Immunity at High Output Level	M600	$T_A = 25^\circ\text{C}, I_F = 0\text{mA}$ $ V_{CM} = 10\text{V(Peak)}$ $V_{OH} = 2.0\text{V}, R_L = 350\Omega$	-	-	-	V/ μs
	M601	$T_A = 25^\circ\text{C}, I_F = 0\text{mA}$ $ V_{CM} = 50\text{V(Peak)}$ $V_{OH} = 2.0\text{V}, R_L = 350\Omega$	5000	-	-	
	M611	$T_A = 25^\circ\text{C}, I_F = 0\text{mA}$ $ V_{CM} = 1000\text{V(Peak)}$ $V_{OH} = 2.0\text{V}, R_L = 350\Omega$	20000	-	-	
输出低电平共模瞬态抑制 Common Mode Transient Immunity at Low Output Level	M600	$I_F = 7.5\text{mA}, V_{OL} = 0.8\text{V}$ $R_L = 350\Omega, T_A = 25^\circ\text{C}$ $ V_{CM} = 10\text{V(Peak)}$	-	-	-	V/ μs
	M601	$I_F = 7.5\text{mA}, V_{OL} = 0.8\text{V}$ $R_L = 350\Omega, T_A = 25^\circ\text{C}$ $ V_{CM} = 50\text{V(Peak)}$	5000	-	-	
	M611	$I_F = 7.5\text{mA}, V_{OL} = 0.8\text{V}$ $R_L = 350\Omega, T_A = 25^\circ\text{C}$ $ V_{CM} = 1000\text{V(Peak)}$	20000	-	-	

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 Low-level voltage vs. Ambient temperature

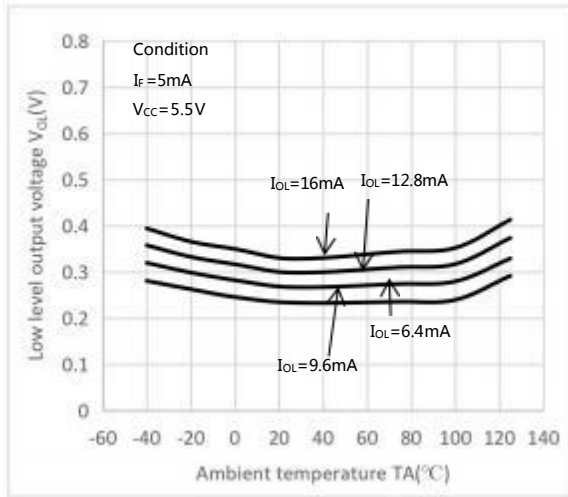


Fig.2 Forward current voltage vs. Forward voltage

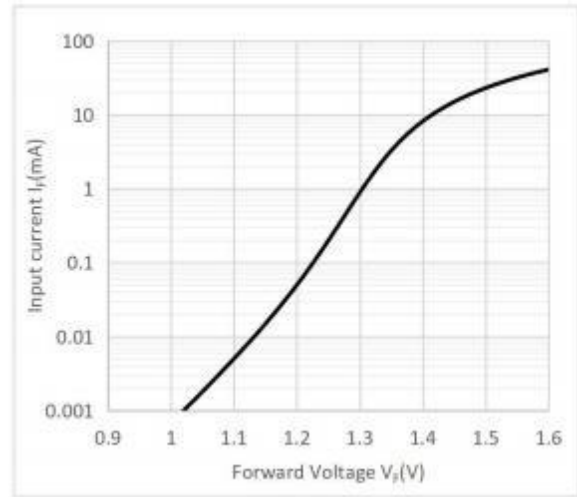


Fig.3 Switch time vs. Forward current

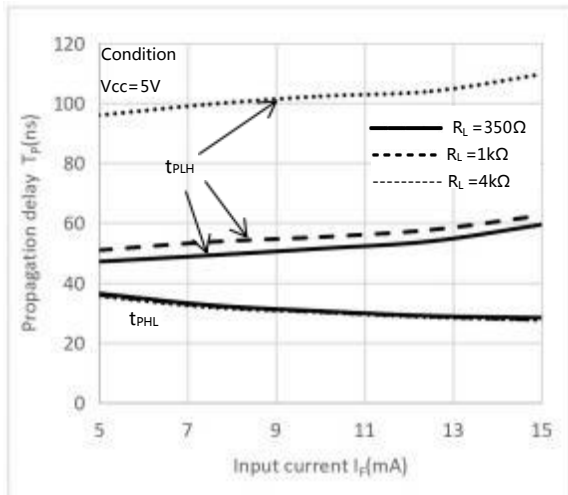


Fig.4 Low-level output current vs. Ambient temperature

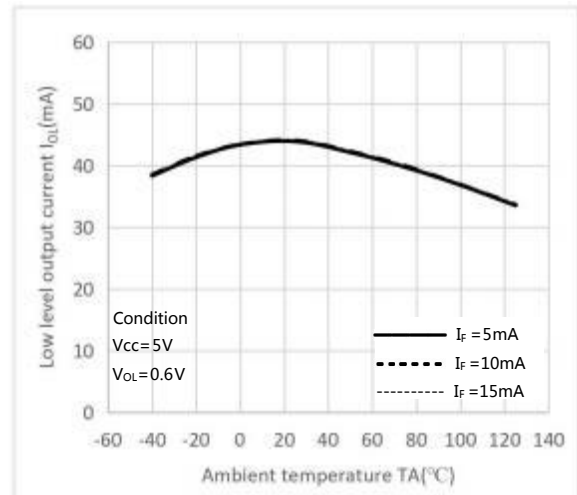


Fig.5 Starting current vs. Ambient temperature

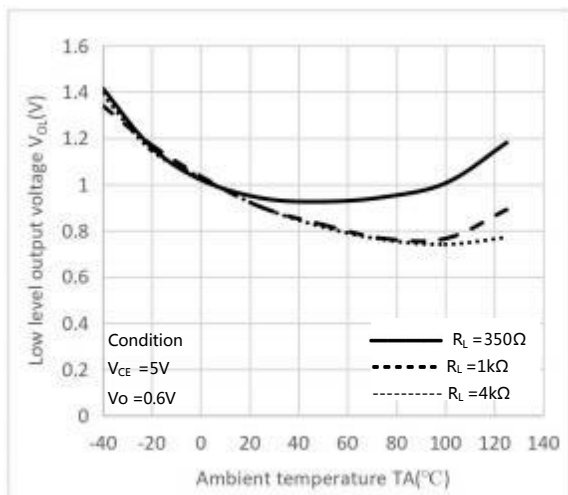


Fig.6 Output voltage vs. Input Forward current

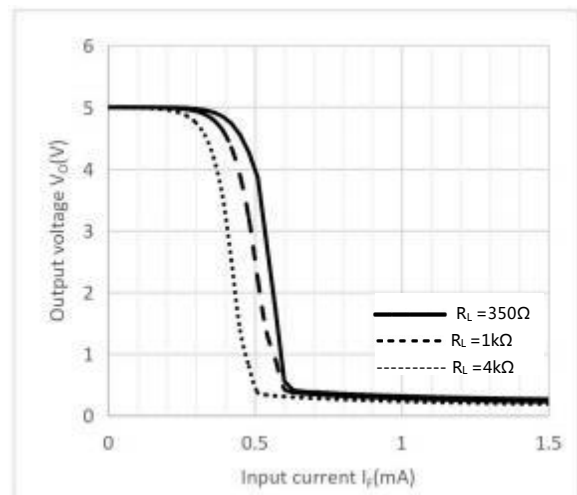


Fig.7 Pulse-width distortion vs. Ambient temperature

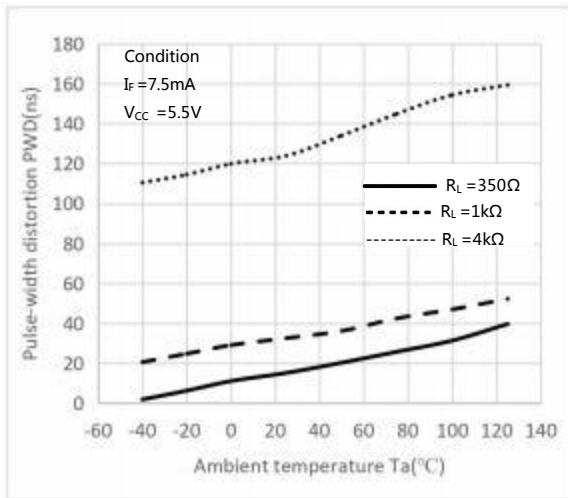


Fig.8 Switch time vs. Ambient temperature

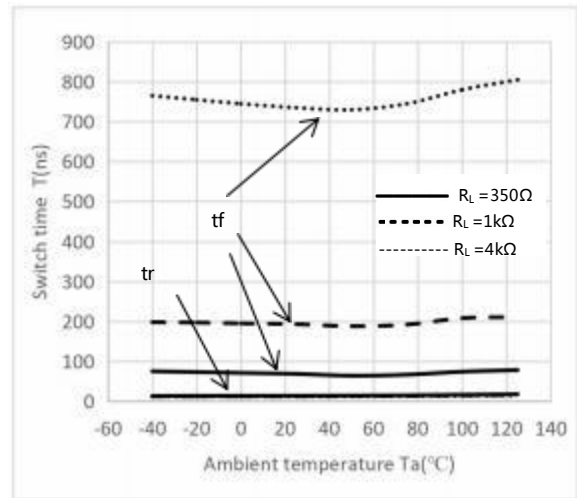


Fig.9 Propagation delay vs. Ambient temperature

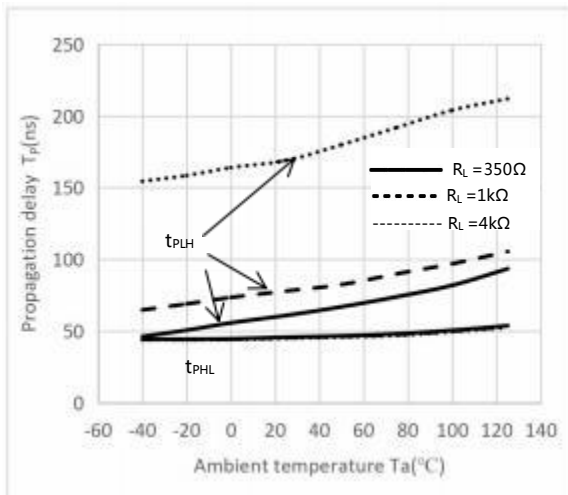
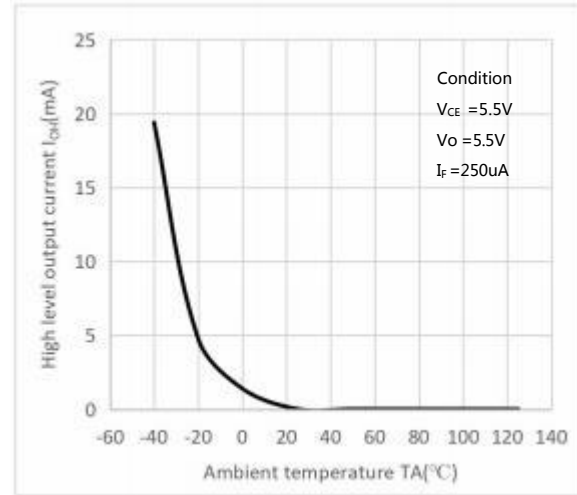
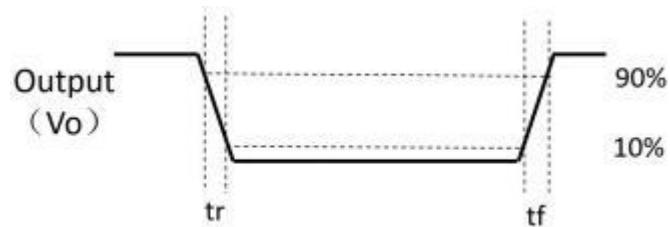
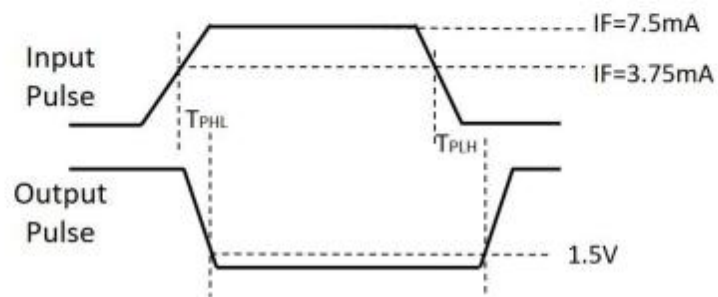
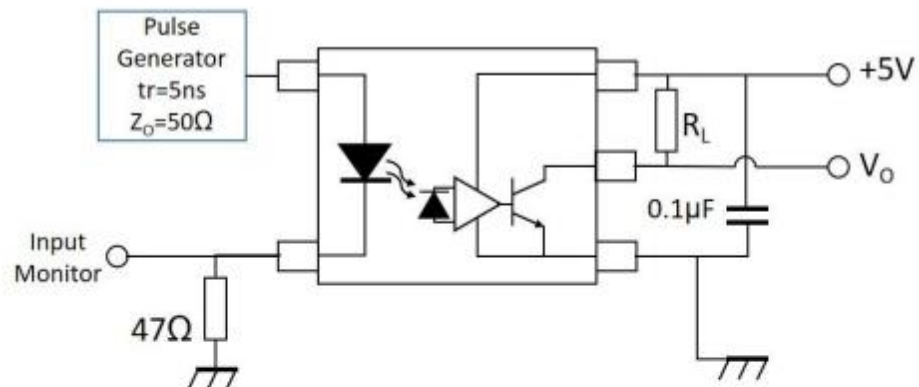


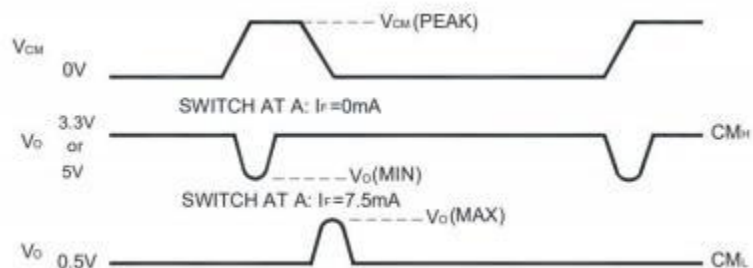
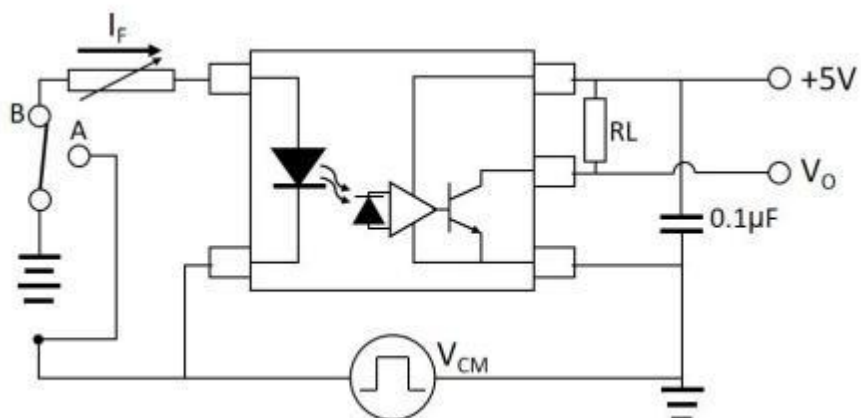
Fig.10 High-level output current vs. Ambient temperature



开关时间测试电路 Witch Time Test Circuit

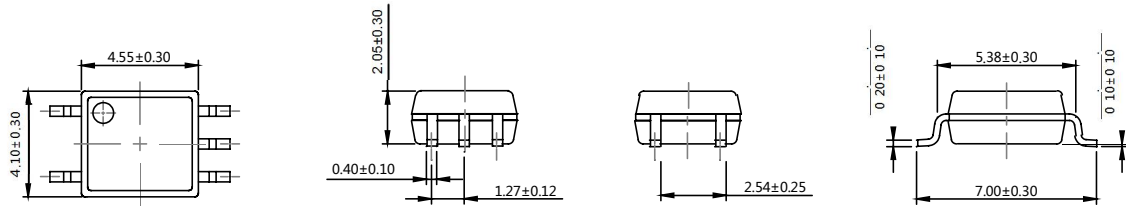


CMR 测试电路 Test Circuit for Common Mode Transient Immunity



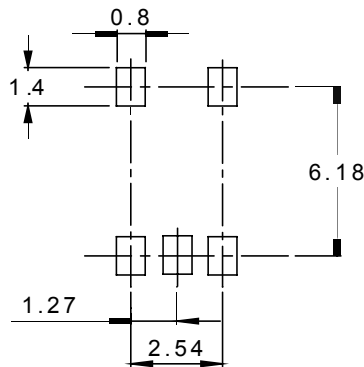
外形尺寸 Outline Dimensions

SOP5



单位 Unit: mm

建议焊盘布局 Recommended Pad Layout

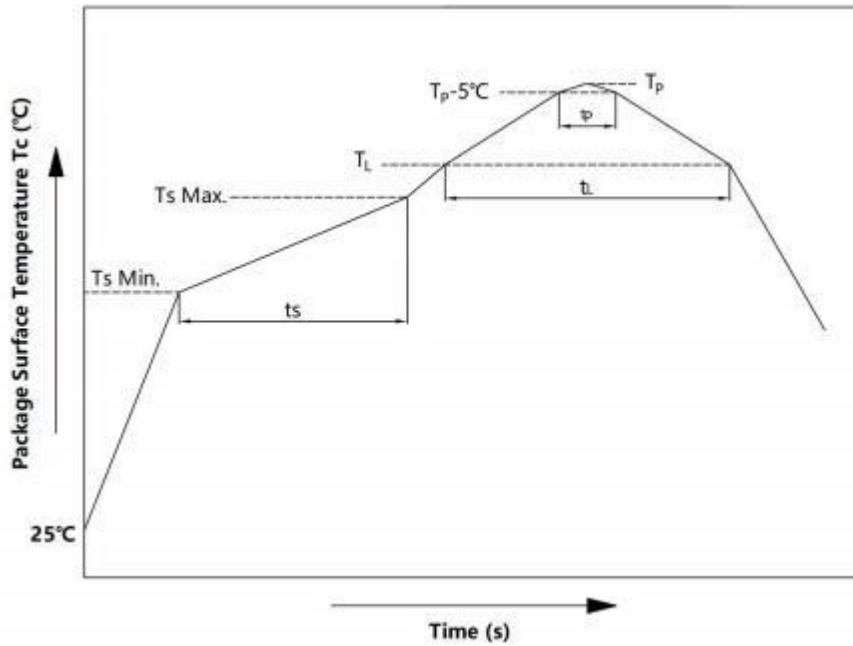


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 Solder Reflow Profile



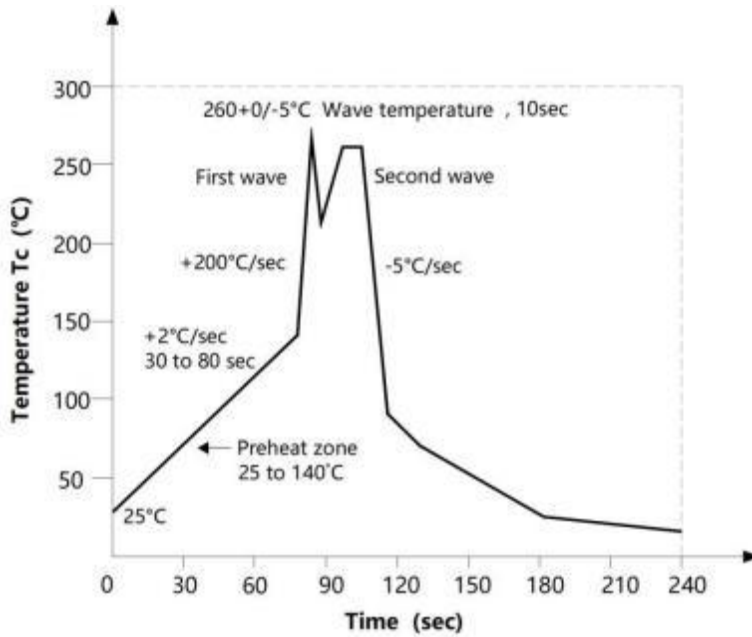
项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	T_s	150	200	$^\circ\text{C}$
预热时间 Preheat Time	t_s	60	120	s
升温速率 Ramp-Up Rate (T_L to T_p)	-	-	3	$^\circ\text{C/s}$
液相线温度 Liquidus Temperature	T_L	217		$^\circ\text{C}$
时间高于 T_L Time Above T_L	t_L	60	150	s
峰值温度 Peak Temperature	T_p	-	260	$^\circ\text{C}$
T_c 在 $(T_p - 5)$ 和 T_p 之间的时间 Time During Which T_c Is Between $(T_p - 5)$ and T_p	t_p	-	30	s
降温速率 Ramp-down Rate (T_p to T_L)	-	-	6	$^\circ\text{C/s}$

注 Note :

建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；

Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

- A. 手工烙铁焊仅用于产品返修或样品测试；
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求：温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ，时间 $\leq 3\text{s}$ 。
Hand soldering iron requirements：Temperature： $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

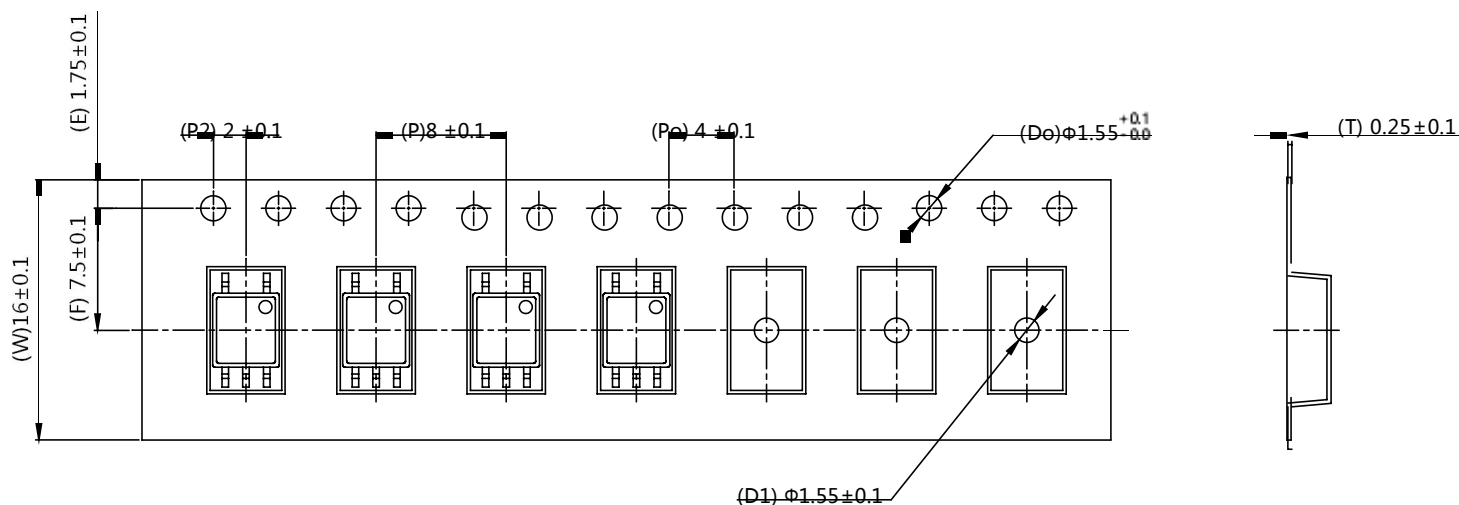
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SOP5	编带 ($\phi 330$ mm 蓝)	3k /盘	2 盘/盒	10 盒/箱	450*390*0.1mm	340*60*340mm	620*360*365mm	保护带 200mm (min)
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP5	Reel($\phi 330$ mm Blue)	3k pcs/reel	2 reels /box	10 boxes /ctn	450*390*0.1mm	340*60*340mm	620*360*365mm	Guard band 200mm min.

■ 编带包装 Tape & Reel

- 1) 每卷数量：3000 只。
Qty/reel：3000 pcs.
- 2) 每箱数量：60000 只。
Qty/ctn：60000 pcs.
- 3) 内包装：每盒 2 盘。
Inner packing：2 reels/box.
- 4) 示意图 Schematic：



单位 Unit：mm

注意 Attention

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